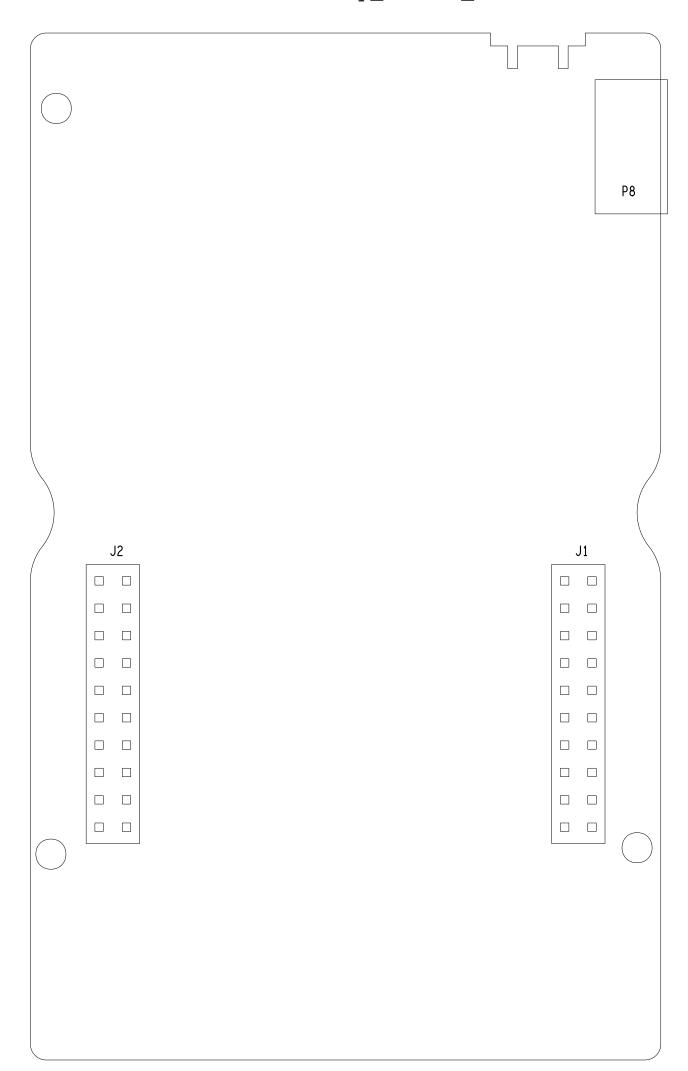


ART FILM - assembly_top

ART FILM - assembly_bottom_mirrored



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